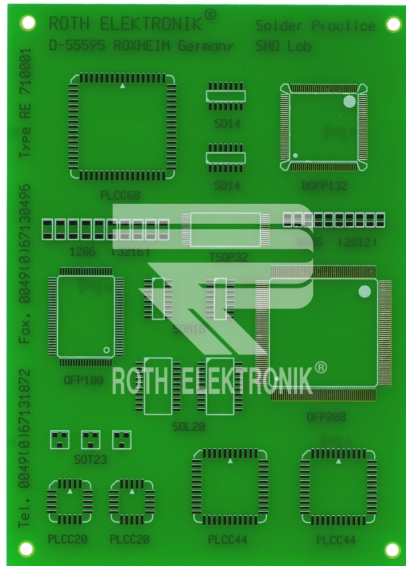


### TSSOP-SMD Multiadapter (thin shrink small outline package)



### RE710001-LF



- PCB for SMD standard and fine pitch solder practices
- also suitable for pick-and-place.
- EPOXY resin FR4 1.50 mm, single-sided 35 µm CU
- Solder side hot air leveling coated (HAL-leadfree), solder stop mask and additional print
- size 100 x 140 mm

### - 38 different SMD Components:

PLCC:	2x20, 2x44, 68
QFP:	100 rect., 132 sq., 208 sq.
TSOP 32:	1x
SOT 23:	3x
SO 14:	2x
SOM 16:	2x
SOL 20:	2x
0805 Chip Kond.:	10x
1206 Chip Kond.:	10x